COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

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My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

WAFER LEVEL TESTING AND BUMPING PROCESS

the specification of wh	ich			
X is attached heret	o .			
was filed on				
as Application Se	erial No	and was amended o	n	<u> </u>
I acknowledge the application in accordant I hereby claim for application(s) for pate	the claims, as amend ne duty to disclose infonce with Title 37, Code preign priority benefits of ent or inventor's certification or inventor's ceimed:	and understand the coned by any amendment refeormation which is material of Federal Regulations, § under Title 35, United Staticate listed below and hartificate having a filing date	erred to above. al to the paten 1.56(a). tes Code, §119 ave also identi	atability of this of any foreign fied below any
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
92103361	Taiwan, R.O.C.	2003/2/19	X	
I hereby appoint transact all business in Jiawei Huang Maria Erlinda C. Sa Belinda Lee	the Patent and Trade (Reg. No. 43,33	36)	secute this apperewith: (Reg. No.	
SEND CORRESPONDENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number)		
J.C. Patents, Inc. 4 Venture, Suite 250, Irvine, CA 92618 (949) 660-0761		Jiawei Huang (949) 660-0762		

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:

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